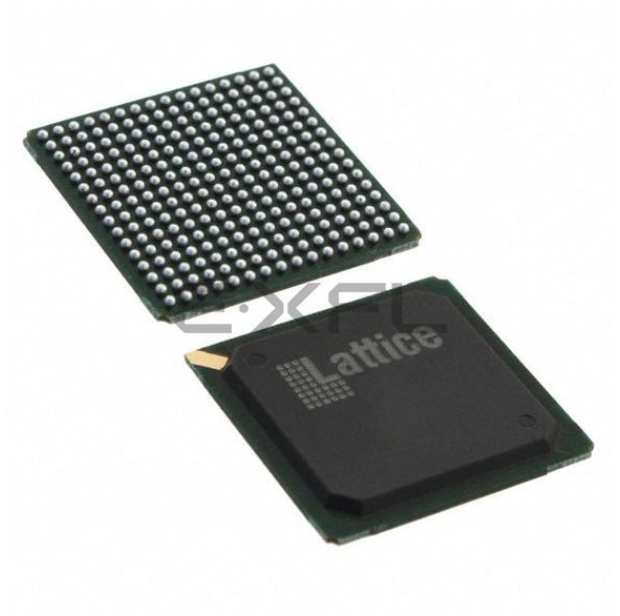
Lattice Semiconductor Corporation - LFE2-6SE-6FN256I Datasheet



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Details	
Product Status	Active
Number of LABs/CLBs	750
Number of Logic Elements/Cells	6000
Total RAM Bits	56320
Number of I/O	190
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	256-BGA
Supplier Device Package	256-FPBGA (17x17)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2-6se-6fn256i

LatticeECP2/M Family Data Sheet Architecture

September 2013 **Data Sheet DS1006**

Architecture Overview

Each LatticeECP2/M device contains an array of logic blocks surrounded by Programmable I/O Cells (PIC). Interspersed between the rows of logic blocks are rows of sysMEM™ Embedded Block RAM (EBR) and rows of sysDSP™ Digital Signal Processing blocks, as shown in Figure 2-1. In addition, the LatticeECP2M family contains SERDES Quads in one or more of the corners. Figure 2-2 shows the block diagram of ECP2M20 with one quad.

There are two kinds of logic blocks, the Programmable Functional Unit (PFU) and Programmable Functional Unit without RAM (PFF). The PFU contains the building blocks for logic, arithmetic, RAM and ROM functions. The PFF block contains building blocks for logic, arithmetic and ROM functions. Both PFU and PFF blocks are optimized for flexibility, allowing complex designs to be implemented quickly and efficiently. Logic Blocks are arranged in a two-dimensional array. Only one type of block is used per row.

The LatticeECP2/M devices contain one or more rows of sysMEM EBR blocks. sysMEM EBRs are large dedicated 18K fast memory blocks. Each sysMEM block can be configured in a variety of depths and widths of RAM or ROM. In addition, LatticeECP2/M devices contain up to two rows of DSP Blocks. Each DSP block has multipliers and adder/accumulators, which are the building blocks for complex signal processing capabilities.

The LatticeECP2M devices feature up to 16 embedded 3.125Gbps SERDES (Serializer / Deserializer) channels. Each SERDES channel contains independent 8b/10b encoding / decoding, polarity adjust and elastic buffer logic. Each group of four SERDES channels along with its Physical Coding Sub-layer (PCS) block, creates a quad. The functionality of the SERDES/PCS Quads can be controlled by memory cells set during device configuration or by registers that are addressable during device operation. The registers in every quad can be programmed by a soft IP interface, referred to as the SERDES Client Interface (SCI). These quads (up to four) are located at the corners of the devices.

Each PIC block encompasses two PIOs (PIO pairs) with their respective sysI/O buffers. The sysI/O buffers of the LatticeECP2/M devices are arranged in eight banks, allowing the implementation of a wide variety of I/O standards. In addition, a separate I/O bank is provided for the programming interfaces. PIO pairs on the left and right edges of the device can be configured as LVDS transmit/receive pairs. The PIC logic also includes pre-engineered support to aid in the implementation of high speed source synchronous standards such as SPI4.2, along with memory interfaces including DDR2.

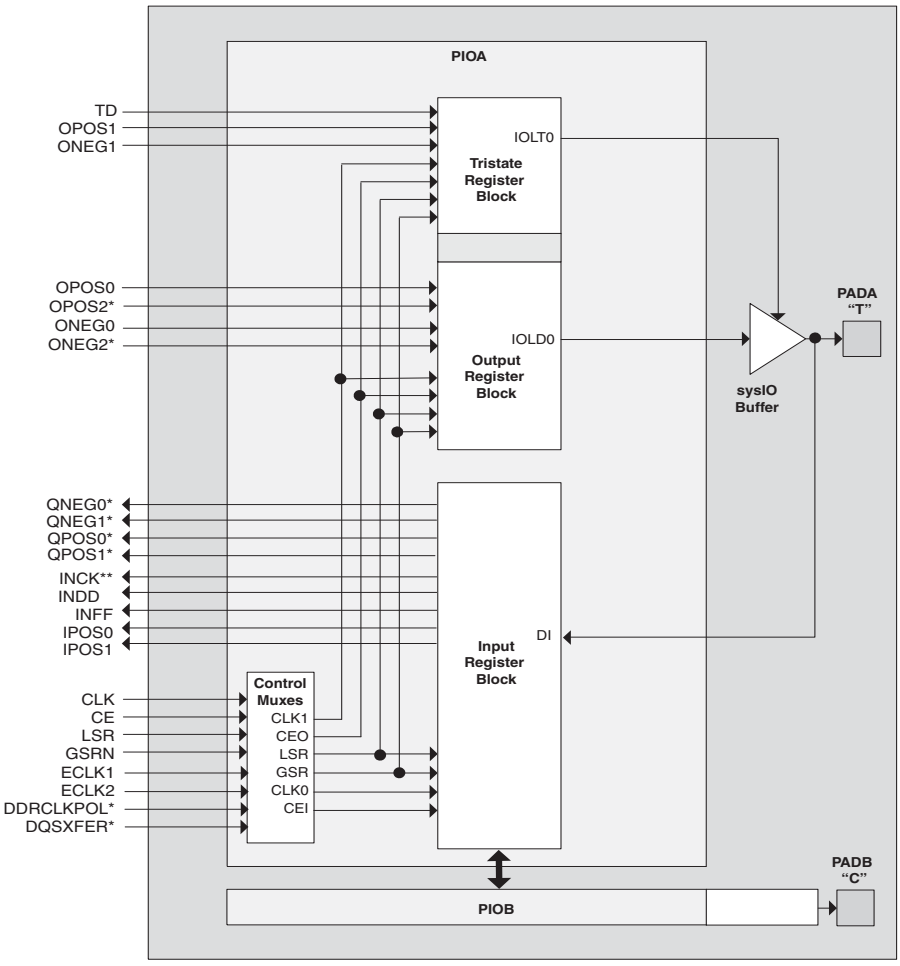
The LatticeECP2/M registers in PFU and sysI/O can be configured to be SET or RESET. After power up and the device is configured, it enters into user mode with these registers SET/RESET according to the configuration setting, allowing the device entering to a known state for predictable system function.

Other blocks provided include PLLs, DLLs and configuration functions. The LatticeECP2/M architecture provides two General PLLs (GPLL) and up to six Standard PLLs (SPLL) per device. In addition, each LatticeECP2/M family member provides two DLLs per device. The GPLLs and DLLs blocks are located in pairs at the end of the bottom-most EBR row; the DLL block is located towards the edge of the device. The SPLL blocks are located at the end of the other EBR/DSP rows.

The configuration block that supports features such as configuration bit-stream decryption, transparent updates and dual boot support is located toward the center of this EBR row. The Ball Grid Array (BGA) package devices in the LatticeECP2/M family supports a sysCONFIG™ port located in the corner between banks four and five, which allows for serial or parallel device configuration.

In addition, every device in the family has a JTAG port. This family also provides an on-chip oscillator. The LatticeECP2/M devices use 1.2V as their core voltage.

Figure 2-28. PIC Diagram



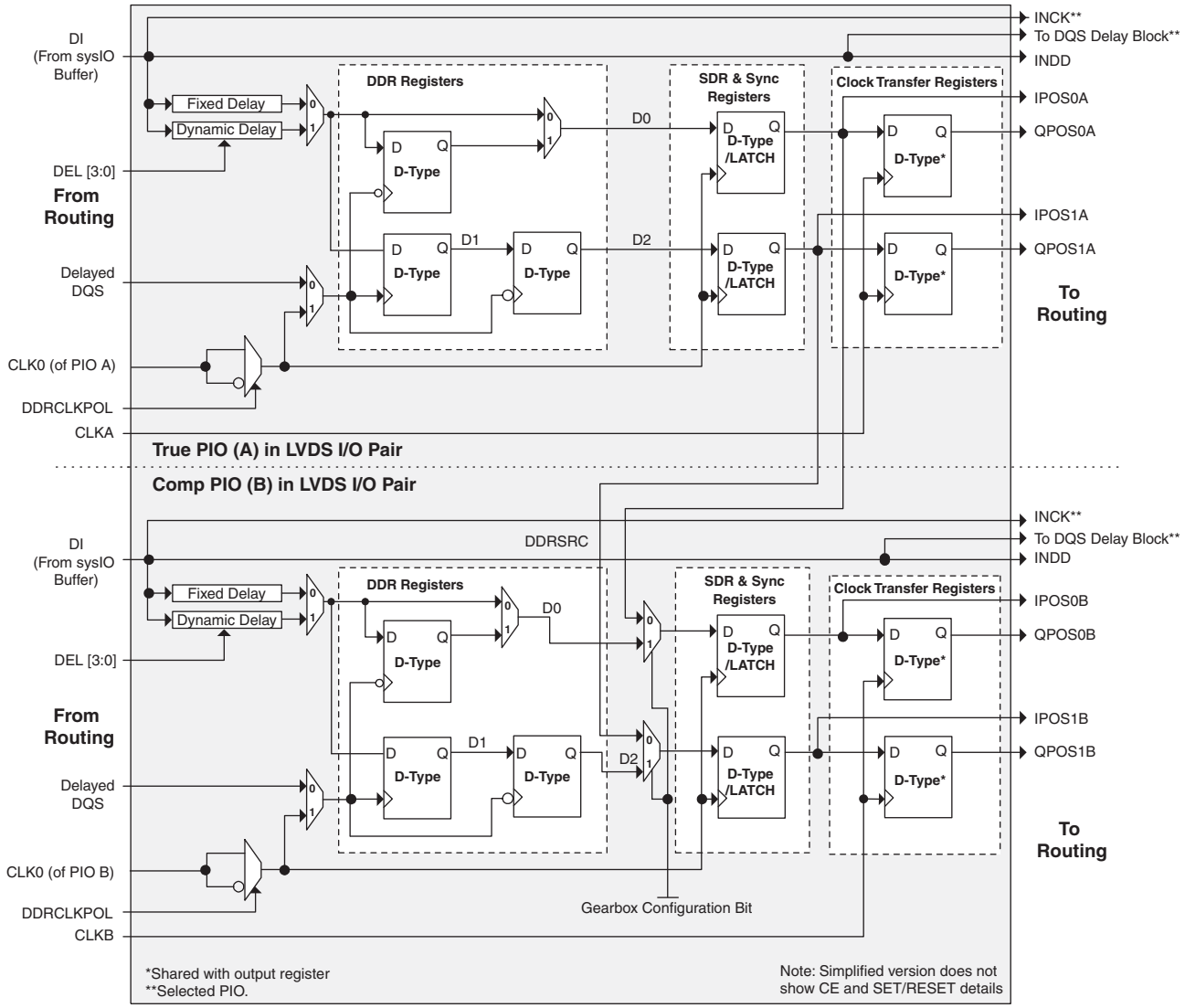
*Signals are available on left/right/bottom edges only.
** Selected blocks.

Two adjacent PIOs can be joined to provide a differential I/O pair (labeled as “T” and “C”) as shown in Figure 2-28. The PAD Labels “T” and “C” distinguish the two PIOs. Approximately 50% of the PIO pairs on the left and right edges of the device can be configured as true LVDS outputs. All I/O pairs can operate as inputs.

By combining input blocks of the complementary PIOs and sharing some registers from output blocks, a gearbox function can be implemented, which takes a double data rate signal applied to PIOA and converts it as four data streams, IPOS0A, IPOS1A, IPOS0B and IPOS1B. Figure 2-29 shows the diagram using this gearbox function. For more information about this topic, please see information regarding additional documentation at the end of this data sheet.

The signal DDRCLKPOL controls the polarity of the clock used in the synchronization registers. It ensures adequate timing when data is transferred from the DQS to the system clock domain. For further information about this topic, see the DDR Memory section of this data sheet.

Figure 2-29. Input Register Block for Left, Right and Bottom Edges



LatticeECP2M Initialization Supply Current[1, 2, 3, 4]

Over Recommended Operating Conditions

Symbol	Parameter	Device	Typ.[5, 6, 7]	Units
I_{CC}	Core Power Supply Current	ECP2M20	41	mA
		ECP2M35	107	mA
		ECP2M50	169	mA
		ECP2M70	254	mA
		ECP2M100	378	mA
I_{CCAUX}	Auxiliary Power Supply Current	ECP2M20	30	mA
		ECP2M35	30	mA
		ECP2M50	30	mA
		ECP2M70	30	mA
		ECP2M100	30	mA
I_{CCGPLL}	GPLL Power Supply Current (per GPLL)	All Devices	0.5	mA
I_{CCSPLL}	SPLL Power Supply Current (per SPLL)	All Devices	0.5	mA
I_{CCIO}	Bank Power Supply Current (per Bank)	All Devices	3	mA
I_{CCJ}	VCCJ Power Supply Current	All Devices	4	mA

1. Until DONE signal is active.
2. For further information about supply current, please see the list of additional technical documentation at the end of this data sheet.
3. Assumes all outputs are tristated, all inputs are configured as LVCMOS and held at the V_{CCIO} or GND.
4. Frequency 0MHz.
5. T_J = 25ºC, power supplies at nominal voltage.
6. A specific configuration pattern is used that scales with the size of the device; consists of 75% PFU utilization, 50% EBR, and 25% I/O configuration.
7. Values shown in this column are the typical average DC current during configuration. Use the Power Calculator tool to find the peak startup current.

sysCLOCK GPLL Timing

Over Recommended Operating Conditions

Parameter	Description	Conditions	Min.	Typ.	Max.	Units
f_{IN}	Input Clock Frequency (CLKI, CLKFB)	Without external capacitor	20	—	420	MHz
		With external capacitor[5, 6]	2	—	420	MHz
f_{OUT}	Output Clock Frequency (CLKOP, CLKOS)	Without external capacitor	20	—	420	MHz
		With external capacitor[5]	5	—	50	MHz
f_{OUT2}	K-Divider Output Frequency (CLKOK)	Without external capacitor	0.156	—	210	MHz
		With external capacitor[5]	0.039	—	25	MHz
f_{VCO}	PLL VCO Frequency		640	—	1280	MHz
f_{PFD}	Phase Detector Input Frequency	Without external capacitor	20	—	420	MHz
		With external capacitor[5, 6]	2	—	50	MHz
AC Characteristics						
t_{DT}	Output Clock Duty Cycle	Default duty cycle selected[3]	45	50	55	%
t_{PH}[4]	Output Phase Accuracy		—	—	±0.05	UI
t_{OPJIT}[1]	Output Clock Period Jitter	$f_{OUT} \geq 100$ MHz	—	—	±125	ps
		$50 \leq f_{OUT} < 100$ MHz	—		0.025	UIPP
		$f_{OUT} < 50$ MHz	—	—	0.04	UIPP
t_{SK}	Input Clock to Output Clock Skew	N/M = integer	—	—	±250	ps
t_W	Output Clock Pulse Width	At 90% or 10%	1	—	—	ns
t_{LOCK}[2]	PLL Lock-in Time	Without external capacitor	—	—	150	µs
		With external capacitor[5]	—	—	500	µs
t_{PA}	Programmable Delay Unit		85	130	360	ps
t_{IPJIT}	Input Clock Period Jitter		—	—	±200	ps
t_{FBKDLY}	External Feedback Delay		—	—	10	ns
t_{HI}	Input Clock High Time	90% to 90%	0.5	—	—	ns
t_{LO}	Input Clock Low Time	10% to 10%	0.5	—	—	ns
t_{RST}	RST Pulse Width (RESETM/RESETK)		15	—	—	ns
	Reset Signal Pulse Width (CNTRST)	Without external capacitor	500	—	—	ns
		With external capacitor[5]	20	—	—	µs

1. Jitter sample is taken over 10,000 samples of the primary PLL output with clean reference clock and no additional I/O pins toggling.
2. Output clock is valid after t_{LOCK} for PLL reset and dynamic delay adjustment.
3. Using LVDS output buffers.
4. Relative to CLKOP.
5. Value of external capacitor: 5.6 nF ±20%, NPO dielectric, ceramic chip capacitor, 1206 or smaller package, connected to PLLCAP pin.
6. f_{OUT} (max) = f_{IN} * 10 for f_{IN} < 5MHz.

Signal Descriptions (Cont.)

Signal Name	I/O	Description
[LOC]_SQ_VCCIBm	—	Input buffer power supply, channel m (1.2V/1.5V). This pin should be left floating if the channel is unused.
[LOC]_SQ_VCCOBm	—	Output buffer power supply, channel m (1.2V/1.5V). This pin should be left floating if the channel is unused.
[LOC]_SQ_HDOUTNm	O	High-speed output, negative channel m
[LOC]_SQ_HDOUTPm	O	High-speed output, positive channel m
[LOC]_SQ_HDINNm	I	High-speed input, negative channel m
[LOC]_SQ_HDINPm	I	High-speed input, positive channel m
[LOC]_SQ_VCCTXm[4]	—	Transmitter power supply, channel m (1.2V). This pin must be tied to 1.2V even if the channel is unused.
[LOC]_SQ_VCCRXm[4]	—	Receiver power supply, channel m (1.2V). This pin must be tied to 1.2V even if the channel is unused.

1. These signals are relevant for LatticeECP2M family.
2. m defines the associated channel in the Quad.
3. These signals are defined in Quads [LOC] indicates the corner SERDES Quad is located: ULC (upper left), URC (upper right), LLC (lower left), LRC (lower right).
4. When placing switching I/Os around these critical pins that are designed to supply the device with the proper reference or supply voltage, care must be given. For more information, refer to TN1159, LatticeECP2/M Pin Assignment Recommendations.
5. There may be SPLLs that do not have dedicated I/Os.

LatticeECP2 Pin Information Summary, LFE2-50 and LFE2-70

Pin Type		LFE2-50		LFE2-70	
		484 fpBGA	672 fpBGA	672 fpBGA	900 fpBGA
Single Ended User I/O		339	500	500	583
Differential Pair User I/O		169	249	249	290
Configuration	TAP Pins	5	5	5	5
	Muxed Pins	14	14	14	14
	Dedicated Pins (Non TAP)	7	7	7	7
Non Configuration	Muxed Pins	68	79	79	89
	Dedicated Pins	3	3	3	3
VCC		16	20	20	26
VCCAUX		16	16	16	17
VCCPLL		4	4	2	4
VCCIO	Bank0	4	5	5	6
	Bank1	4	5	5	6
	Bank2	4	5	5	6
	Bank3	4	5	5	6
	Bank4	4	5	5	6
	Bank5	4	5	5	6
	Bank6	4	5	5	6
	Bank7	4	5	5	6
	Bank8	2	2	2	2
GND, GND0 to GND7		60	72	72	104
NC		0	3	5	101
Single Ended/ Differential I/O Pairs per Bank (including emulated with resistors)	Bank0	50/25	67/33	67/33	84/42
	Bank1	46/23	66/33	66/33	76/38
	Bank2	38/19	56/28	56/28	74/37
	Bank3	22/11	48/24	48/24	48/24
	Bank4	46/23	62/31	62/31	72/35
	Bank5	46/23	68/34	68/34	80/40
	Bank6	40/20	64/32	64/32	64/32
	Bank7	37/18	55/27	55/27	71/35
	Bank8	14/7	14/7	14/7	14/7
True LVDS I/O Pairs per Bank	Bank0 (Top Edge)	0	0	0	0
	Bank1 (Top Edge)	0	0	0	0
	Bank2 (Right Edge)	9	13	13	18
	Bank3 (Right Edge)	5	12	12	12
	Bank4 (Bottom Edge)	0	0	0	0
	Bank5 (Bottom Edge)	0	0	0	0
	Bank6 (Left Edge)	10	16	16	16
	Bank7 (Left Edge)	8	12	12	16
	Bank8 (Right Edge)	0	0	0	0

LatticeECP2M Power Supply and NC (Cont.)

Signal	672 fpBGA	900 fpBGA
V_{CC}	**LFE2M35:** AD13, AD14, AD16, AD17, AD19, AD21, AD22, AD24, AD25, L12, L13, L14, L15, M11, M12, M15, M16, N11, N16, P11, P16, R11, R12, R15, R16, T12, T13, T14, T15 **LFE2M50:** L12, L13, L14, L15, M11, M12, M15, M16, N11, N16, P11, P16, R11, R12, R15, R16, T12, T13, T14, T15	**LFE2M50:** AH1, AH4, AH5, AH2, AH7, AH12, AH9, AH10, AH13, C13, C10, C9, C12, C7, C2, C5, C4, C1, L12, L13, L18, L19, M11, M12, M13, M14, M15, M16, M17, M18, M19, M20, N11, N12, N19, N20, P12, P19, R12, R19, T12, T19, U12, U19, V11, V12, V19, V20, W11, W12, W13, W14, W15, W16, W17, W18, W19, W20, Y12, Y13, Y18, Y19 **LFE2M70/LFE2M100:** L12, L13, L18, L19, M11, M12, M13, M14, M15, M16, M17, M18, M19, M20, N11, N12, N19, N20, P12, P19, R12, R19, T12, T19, U12, U19, V11, V12, V19, V20, W11, W12, W13, W14, W15, W16, W17, W18, W19, W20, Y12, Y13, Y18, Y19
V_{CCIO0}	B12, B7, F11, J13, K12	D14, E6, E9, F12, K12, K13
V_{CCIO1}	D18, F16, J14, K15	D17, E22, E25, F19, K18, K19
V_{CCIO2}	G25, L21, M17, M25, N18	F28, J25, K28, M21, M24, N21, N28, P21, R25
V_{CCIO3}	P18, R17, R25, T21, Y25	AA28, AB25, AE28, T25, U21, V21, V28, W21, W24
V_{CCIO4}	AA16, AC18, U15, V14	AA18, AA19, AE19, AF22, AG17, AG25
V_{CCIO5}	AA11, AE12, AE7, U12, V13	AA12, AA13, AE12, AF9, AG14, AG6
V_{CCIO6}	P9, R10, R2, T6, Y2	AA3, AB6, AE3, T6, U10, V10, V3, W10, W7
V_{CCIO7}	G2, L6, M10, M2, N9	F3, J6, K3, M10, M7, N10, N3, P10, R6
V_{CCIO8}	AC24, U17	AA25, AD28
V_{CCJ}	AA7	AG1
V_{CCAUX}	**LFE2M35:** AE19, J11, J12, J15, J16, L18, L9, M18, M9, R18, R9, T18, T9, V11, V12, V15, V16 **LFE2M50:** J11, J12, J15, J16, L18, L9, M18, M9, R18, R9, T18, T9, V11, V12, V15, V16	**LFE2M50:** AJ7, B7, AA10, AA11, AA20, AA21, K10, K11, K20, K21, L10, L11, L20, L21, Y10, Y11, Y20, Y21 **LFE2M70/LFE2M100:** AA10, AA11, AA20, AA21, K10, K11, K20, K21, L10, L11, L20, L21, Y10, Y11, Y20, Y21
V_{CCPLL}	H7, K6, P7, R8, V18, P20, J17, G19	N13, N18, V13, V18
SERDES Power[3]	**LFE2M35:** C25, B25, C22, A22, C21, C20, C24, C23, B19, C19, C15, C14, C18, C17, A16, C16, B13, C13 **LFE2M50:** AD13, AE13, AD16, AF16, AD17, AD18, AD14, AD15, AD19, AE19, AD23, AD24, AD20, AD21, AF22, AD22, AE25, AD25, C25, B25, C22, A22, C21, C20, C24, C23, B19, C19, C15, C14, C18, C17, A16, C16, B13, C13	**LFE2M50:** AH18, AJ18, AH21, AK21, AH22, AH23, AH19, AH20, AH24, AJ24, AH28, AH29, AH25, AH26, AK27, AH27, AJ30, AH30, C30, B30, C27, A27, C26, C25, C29, C28, B24, C24, C20, C19, C23, C22, A21, C21, B18, C18 **LFE2M70/LFE2M100:** C13, B13, C10, A10, C9, C8, C12, C11, B7, C7, C3, C2, C6, C5, A4, C4, B1, C1, C30, B30, C27, A27, C26, C25, C29, C28, B24, C24, C20, C19, C23, C22, A21, C21, B18, C18, AH18, AJ18, AH21, AK21, AH22, AH23, AH19, AH20, AH24, AJ24, AH28, AH29, AH25, AH26, AK27, AH27, AJ30, AH30, AH1, AJ1, AH4, AK4, AH5, AH6, AH2, AH3, AH7, AJ7, AH11, AH12, AH8, AH9, AK10, AH10, AJ13, AH13

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 144 TQFP (Cont.)

LFE2-6E/SE					LFE2-12E/12SE			
Pin Number	Pin/Pad Function	Bank	Dual Function	Differential	Pin/Pad Function	Bank	Dual Function	Differential
136	PT6B	0		C	PT16B	0		C
137	PT6A	0		T	PT16A	0		T
138	GND	-			GND	-		
139	VCCIO0	0			VCCIO0	0		
140	PT4B	0		C	PT6B	0		C
141	PT4A	0		T	PT6A	0		T
142	VCCAUX	-			VCCAUX	-		
143	PT2B	0	VREF2_0	C	PT2B	0	VREF2_0	C
144	PT2A	0	VREF1_0	T	PT2A	0	VREF1_0	T

* Supports true LVDS. Other differential signals must be emulated with external resistors.
** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one-to-one connection with a package ball or pin.

LFE2-20E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2-20E/SE					
Ball Number	Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
L11	L11	PB61B	4	BDQ60	C
T13	T13	PB62A	4	BDQ60	T
R13	R13	PB63A	4	BDQ60	T
VCCIO	VCCIO	VCCIO4	4		
T14	T14	PB62B	4	BDQ60	C
P13	P13	PB63B	4	BDQ60	C
GND	GND	GNDIO4	-		
N12	N12	PB64A	4	VREF2_4/BDQ60	T
M12	M12	PB64B	4	VREF1_4/BDQ60	C
R15	R15	CFG2	8		
N14	N14	CFG1	8		
N13	N13	PROGRAMN	8		
N15	N15	CFG0	8		
P15	P15	PR44B	8	WRITEN	C
L12	L12	INITN	8		
N16	N16	PR43B	8	CSN	C
GND	GND	GNDIO8	-		
R14	R14	CCLK	8		
P14	P14	PR44A	8	CS1N	T
M13	M13	DONE	8		
R16	R16	PR42B	8	D1	C
VCCIO	VCCIO	VCCIO8	8		
M16	M16	PR43A	8	D0/SPIFASTN	T
P16	P16	PR42A	8	D2	T
L15	L15	PR41B	8	D3	C
GND	GND	GNDIO8	-		
L14	L14	PR40A	8	D6	T
L16	L16	PR41A	8	D4	T
L10	L10	PR39B	8	D7/SPID0	C
L13	L13	PR40B	8	D5	C
VCCIO	VCCIO	VCCIO8	8		
K11	K11	PR39A	8	DI/CSSPI0N	T
K14	K14	PR38B	8	DOUT/CSON	C
K13	K13	PR38A	8	BUSY/SISPI	T
GND	GND	GNDIO8	-		
K15	K15	PR31B	3	RLM0_GPLLC_FB_A/RDQ34	C
VCCIO	VCCIO	VCCIO3	3		
K16	K16	PR31A	3	RLM0_GPLLT_FB_A/RDQ34	T
GND	GND	GNDIO3	-		
J16	J16	PR30B	3	RLM0_GPLLC_IN_A**/RDQ34	C (LVDS)*
J15	J15	PR30A	3	RLM0_GPLLT_IN_A**/RDQ34	T (LVDS)*
J14	J14	RLM0_PLLCAP	3		

LFE2-35E/SE and LFE2-50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-35E/SE					LFE2-50E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
U8	PB23A	5	BDQ24	T	PB32A	5	BDQ33	T
U9	PB23B	5	BDQ24	C	PB32B	5	BDQ33	C
W9	PB24A	5	BDQS24	T	PB33A	5	BDQS33	T
GNDIO	GNDIO5	-			GNDIO5	-		
V9	PB24B	5	BDQ24	C	PB33B	5	BDQ33	C
Y8	PB25A	5	BDQ24	T	PB34A	5	BDQ33	T
AA8	PB25B	5	BDQ24	C	PB34B	5	BDQ33	C
W10	PB26A	5	BDQ24	T	PB35A	5	BDQ33	T
VCCIO	VCCIO5	5			VCCIO	5		
V10	PB26B	5	BDQ24	C	PB35B	5	BDQ33	C
AB8	PB27A	5	BDQ24	T	PB36A	5	BDQ33	T
AA9	PB27B	5	BDQ24	C	PB36B	5	BDQ33	C
GNDIO	GNDIO5	-			GNDIO5	-		
AB9	PB29A	5	BDQ33	T	PB38A	5	BDQ42	T
AB10	PB29B	5	BDQ33	C	PB38B	5	BDQ42	C
Y10	PB30A	5	BDQ33	T	PB39A	5	BDQ42	T
AA10	PB30B	5	BDQ33	C	PB39B	5	BDQ42	C
U10	PB31A	5	BDQ33	T	PB40A	5	BDQ42	T
U11	PB31B	5	BDQ33	C	PB40B	5	BDQ42	C
VCCIO	VCCIO5	5			VCCIO	5		
AB11	PB32A	5	BDQ33	T	PB41A	5	BDQ42	T
AA11	PB32B	5	BDQ33	C	PB41B	5	BDQ42	C
GNDIO	GNDIO5	-			GNDIO5	-		
Y11	PB33A	5	BDQS33	T	PB42A	5	BDQS42	T
W11	PB33B	5	BDQ33	C	PB42B	5	BDQ42	C
AB12	PB34A	5	BDQ33	T	PB43A	5	BDQ42	T
AA12	PB34B	5	BDQ33	C	PB43B	5	BDQ42	C
AB13	PB35A	5	PCLKT5_0/BDQ33	T	PB44A	5	PCLKT5_0/BDQ42	T
AB14	PB35B	5	PCLKC5_0/BDQ33	C	PB44B	5	PCLKC5_0/BDQ42	C
VCCIO	VCCIO5	5			VCCIO	5		
GNDIO	GNDIO5	-			GNDIO5	-		
U12	PB40A	4	PCLKT4_0/BDQ42	T	PB49A	4	PCLKT4_0/BDQ51	T
VCCIO	VCCIO4	4			VCCIO	4		
V12	PB40B	4	PCLKC4_0/BDQ42	C	PB49B	4	PCLKC4_0/BDQ51	C
Y12	PB41A	4	BDQ42	T	PB50A	4	BDQ51	T
W12	PB41B	4	BDQ42	C	PB50B	4	BDQ51	C
AA13	PB42A	4	BDQS42	T	PB51A	4	BDQS51	T
GNDIO	GNDIO4	-			GNDIO4	-		
Y13	PB42B	4	BDQ42	C	PB51B	4	BDQ51	C
U13	PB43A	4	BDQ42	T	PB52A	4	BDQ51	T
U14	PB43B	4	BDQ42	C	PB52B	4	BDQ51	C
AB15	PB44A	4	BDQ42	T	PB53A	4	BDQ51	T
VCCIO	VCCIO4	4			VCCIO	4		
AA14	PB44B	4	BDQ42	C	PB53B	4	BDQ51	C
AB16	PB45A	4	BDQ42	T	PB54A	4	BDQ51	T
AB17	PB45B	4	BDQ42	C	PB54B	4	BDQ51	C

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
GND	GNDIO2	-			GNDIO2	-		
L21	PR18B	2	RDQ16	C (LVDS)*	PR24B	2	RDQ22	C (LVDS)*
K22	PR18A	2	RDQ16	T (LVDS)*	PR24A	2	RDQ22	T (LVDS)*
M24	PR17B	2	RDQ16	C	PR23B	2	RDQ22	C
N23	PR17A	2	RDQ16	T	PR23A	2	RDQ22	T
VCCIO	VCCIO2	2			VCCIO2	2		
K26	PR16B	2	RDQ16	C (LVDS)*	PR22B	2	RDQ22	C (LVDS)*
K25	PR16A	2	RDQS16	T (LVDS)*	PR22A	2	RDQS22	T (LVDS)*
M20	PR15B	2	RDQ16	C	PR21B	2	RDQ22	C
GND	GNDIO2	-			GNDIO2	-		
M19	PR15A	2	RDQ16	T	PR21A	2	RDQ22	T
L22	PR14B	2	RDQ16	C (LVDS)*	PR20B	2	RDQ22	C (LVDS)*
M22	PR14A	2	RDQ16	T (LVDS)*	PR20A	2	RDQ22	T (LVDS)*
K21	PR13B	2	RDQ16	C	PR19B	2	RDQ22	C
VCCIO	VCCIO2	2			VCCIO2	2		
M21	PR13A	2	RDQ16	T	PR19A	2	RDQ22	T
K24	PR12B	2	RDQ16	C (LVDS)*	PR18B	2	RDQ22	C (LVDS)*
J24	PR12A	2	RDQ16	T (LVDS)*	PR18A	2	RDQ22	T (LVDS)*
GND	GNDIO2	-			GNDIO2	-		
VCCIO	VCCIO2	2			VCCIO2	2		
L20	VCC	-			NC	-		
GND	GNDIO2	-			GNDIO2	-		
J26	NC	-			NC	-		
J25	NC	-			NC	-		
J23	NC	-			NC	-		
K23	NC	-			NC	-		
VCCIO	VCCIO2	2			VCCIO2	2		
H26	NC	-			NC	-		
H25	NC	-			NC	-		
H24	NC	-			NC	-		
GND	GNDIO2	-			GNDIO2	-		
H23	NC	-			NC	-		
VCCIO	VCCIO2	2			VCCIO2	2		
G26	PR11B	2	RDQ8	C	PR17B	2	RDQ14	C
GND	GNDIO2	-			GNDIO2	-		
G25	PR11A	2	RDQ8	T	PR17A	2	RDQ14	T
F26	PR10B	2	RDQ8	C (LVDS)*	PR16B	2	RDQ14	C (LVDS)*
F25	PR10A	2	RDQ8	T (LVDS)*	PR16A	2	RDQ14	T (LVDS)*
K20	PR9B	2	RDQ8	C	PR15B	2	RDQ14	C
VCCIO	VCCIO2	2			VCCIO2	2		
L19	PR9A	2	RDQ8	T	PR15A	2	RDQ14	T
E26	PR8B	2	RDQ8	C (LVDS)*	PR14B	2	RDQ14	C (LVDS)*
E25	PR8A	2	RDQS8	T (LVDS)*	PR14A	2	RDQS14	T (LVDS)*
GND	GNDIO2	-			GNDIO2	-		
J22	PR7B	2	RDQ8	C	PR13B	2	RDQ14	C
H22	PR7A	2	RDQ8	T	PR13A	2	RDQ14	T

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
A2	GND	-			GND	-		
A25	GND	-			GND	-		
AA18	GND	-			GND	-		
AA24	GND	-			GND	-		
AA3	GND	-			GND	-		
AA9	GND	-			GND	-		
AD11	GND	-			GND	-		
AD16	GND	-			GND	-		
AD21	GND	-			GND	-		
AD6	GND	-			GND	-		
AE1	GND	-			GND	-		
AE26	GND	-			GND	-		
AF2	GND	-			GND	-		
AF25	GND	-			GND	-		
B1	GND	-			GND	-		
B26	GND	-			GND	-		
C11	GND	-			GND	-		
C16	GND	-			GND	-		
C21	GND	-			GND	-		
C6	GND	-			GND	-		
F18	GND	-			GND	-		
F24	GND	-			GND	-		
F3	GND	-			GND	-		
F9	GND	-			GND	-		
J13	GND	-			GND	-		
J14	GND	-			GND	-		
J21	GND	-			GND	-		
J6	GND	-			GND	-		
K10	GND	-			GND	-		
K11	GND	-			GND	-		
K13	GND	-			GND	-		
K14	GND	-			GND	-		
K16	GND	-			GND	-		
K17	GND	-			GND	-		
L10	GND	-			GND	-		
L11	GND	-			GND	-		
L16	GND	-			GND	-		
L17	GND	-			GND	-		
L24	GND	-			GND	-		
L3	GND	-			GND	-		
M13	GND	-			GND	-		
M14	GND	-			GND	-		
N10	GND	-			GND	-		
N12	GND	-			GND	-		
N13	GND	-			GND	-		
N14	GND	-			GND	-		

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	**Ball/Pad Function**	**Bank**	**Dual Function**	**Differential**
P25	PR51B	2	RDQ54	C
VCCIO	VCCIO2	2		
P23	PR51A	2	RDQ54	T
P27	PR50B	2	RDQ54	C (LVDS)*
P28	PR50A	2	RDQ54	T (LVDS)*
GND	GNDIO2	-		
VCCIO	VCCIO2	2		
N24	PR39B	2	RUM0_SPLLC_FB_A/RDQ37	C
N26	PR39A	2	RUM0_SPLLT_FB_A/RDQ37	T
N23	PR38B	2	RUM0_SPLLC_IN_A/RDQ37	C
N25	PR38A	2	RUM0_SPLLT_IN_A/RDQ37	T
VCCIO	VCCIO2	2		
P29	PR37B	2	RDQ37	C (LVDS)*
P30	PR37A	2	RDQS37	T (LVDS)*
M26	PR36B	2	RDQ37	C
GND	GNDIO2	-		
M24	PR36A	2	RDQ37	T
N29	PR35B	2	RDQ37	C (LVDS)*
N30	PR35A	2	RDQ37	T (LVDS)*
M25	PR34B	2	RDQ37	C
VCCIO	VCCIO2	2		
M23	PR34A	2	RDQ37	T
M27	PR33B	2	RDQ37	C (LVDS)*
M28	PR33A	2	RDQ37	T (LVDS)*
L26	PR32B	2	RDQ29	C
GND	GNDIO2	-		
L24	PR32A	2	RDQ29	T
M29	PR31B	2	RDQ29	C (LVDS)*
M30	PR31A	2	RDQ29	T (LVDS)*
L25	PR30B	2	RDQ29	C
VCCIO	VCCIO2	2		
L23	PR30A	2	RDQ29	T
L27	PR29B	2	RDQ29	C (LVDS)*
L28	PR29A	2	RDQS29	T (LVDS)*
GND	GNDIO2	-		
K24	PR28B	2	RDQ29	C
K26	PR28A	2	RDQ29	T
L29	PR27B	2	RDQ29	C (LVDS)*
L30	PR27A	2	RDQ29	T (LVDS)*
VCCIO	VCCIO2	2		
K23	PR26B	2	RDQ29	C
K25	PR26A	2	RDQ29	T
K27	PR25B	2	RDQ29	C (LVDS)*

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	**Ball/Pad Function**	**Bank**	**Dual Function**	**Differential**
U10	VCCIO6	6		
U9	VCCIO6	6		
V10	VCCIO6	6		
W10	VCCIO6	6		
W9	VCCIO6	6		
Y9	VCCIO6	6		
L10	VCCIO7	7		
L9	VCCIO7	7		
M10	VCCIO7	7		
N10	VCCIO7	7		
P10	VCCIO7	7		
R10	VCCIO7	7		
AA21	VCCIO8	8		
Y21	VCCIO8	8		
AA15	VCCAUX	-		
AB11	VCCAUX	-		
AB19	VCCAUX	-		
AB20	VCCAUX	-		
J11	VCCAUX	-		
J12	VCCAUX	-		
J19	VCCAUX	-		
K19	VCCAUX	-		
L22	VCCAUX	-		
M9	VCCAUX	-		
N9	VCCAUX	-		
P21	VCCAUX	-		
P9	VCCAUX	-		
T10	VCCAUX	-		
T21	VCCAUX	-		
V9	VCCAUX	-		
W22	VCCAUX	-		
A1	GND	-		
A30	GND	-		
AC28	GND	-		
AC3	GND	-		
AH13	GND	-		
AH18	GND	-		
AH23	GND	-		
AH28	GND	-		
AH3	GND	-		
AH8	GND	-		
AK1	GND	-		
AK30	GND	-		

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
-	-	-			VCCIO2	2		
H23	NC	-			PR15B	2	RDQ15	C (LVDS)*
H24	NC	-			PR15A	2	RDQS15	T (LVDS)*
D28	NC	-			PR14B	2	RDQ15	C
-	-	-			GNDIO2	-		
E28	NC	-			PR14A	2	RDQ15	T
G24	PR13B	2		C (LVDS)*	PR13B	2	RDQ15	C (LVDS)*
H25	PR13A	2		T (LVDS)*	PR13A	2	RDQ15	T (LVDS)*
D27	PR12B	2	RUM0_SPLLC_FB_A	C	PR12B	2	RUM0_SPLLC_FB_A/RDQ15	C
GNDIO	GNDIO2	-			VCCIO2	2		
E27	PR12A	2	RUM0_SPLLT_FB_A	T	PR12A	2	RUM0_SPLLT_FB_A/RDQ15	T
F26	PR11B	2	RUM0_SPLLC_IN_A	C (LVDS)*	PR11B	2	RUM0_SPLLC_IN_A/RDQ15	C (LVDS)*
G25	PR11A	2	RUM0_SPLLT_IN_A	T (LVDS)*	PR11A	2	RUM0_SPLLT_IN_A/RDQ15	T (LVDS)*
F24	PR9B	2	VREF2_2	C	PR9B	2	VREF2_2	C
VCCIO	VCCIO2	-			-	-		
GNDIO	GNDIO2	-			GNDIO2	-		
F25	PR9A	2	VREF1_2	T	PR9A	2	VREF1_2	T
VCCIO	VCCIO2	2			VCCIO2	2		
G23	XRES	-			XRES	1		
C30	URC_SQ_VCCRX0	12			URC_SQ_VCCRX0	12		
A29	URC_SQ_HDINP0	12		T	URC_SQ_HDINP0	12		T
B30	URC_SQ_VCCIB0	12			URC_SQ_VCCIB0	12		
B29	URC_SQ_HDINN0	12		C	URC_SQ_HDINN0	12		C
C27	URC_SQ_VCCTX0	12			URC_SQ_VCCTX0	12		
A26	URC_SQ_HDOUTP0	12		T	URC_SQ_HDOUTP0	12		T
A27	URC_SQ_VCCOB0	12			URC_SQ_VCCOB0	12		
B26	URC_SQ_HDOUTN0	12		C	URC_SQ_HDOUTN0	12		C
C26	URC_SQ_VCCTX1	12			URC_SQ_VCCTX1	12		
B25	URC_SQ_HDOUTN1	12		C	URC_SQ_HDOUTN1	12		C
C25	URC_SQ_VCCOB1	12			URC_SQ_VCCOB1	12		
A25	URC_SQ_HDOUTP1	12		T	URC_SQ_HDOUTP1	12		T
C29	URC_SQ_VCCRX1	12			URC_SQ_VCCRX1	12		
B28	URC_SQ_HDINN1	12		C	URC_SQ_HDINN1	12		C
C28	URC_SQ_VCCIB1	12			URC_SQ_VCCIB1	12		
A28	URC_SQ_HDINP1	12		T	URC_SQ_HDINP1	12		T
B24	URC_SQ_VCCAUX33	12			URC_SQ_VCCAUX33	12		
E24	URC_SQ_REFCLKN	12		C	URC_SQ_REFCLKN	12		C
D24	URC_SQ_REFCLKP	12		T	URC_SQ_REFCLKP	12		T
C24	URC_SQ_VCCP	12			URC_SQ_VCCP	12		
A20	URC_SQ_HDINP2	12		T	URC_SQ_HDINP2	12		T
C20	URC_SQ_VCCIB2	12			URC_SQ_VCCIB2	12		
B20	URC_SQ_HDINN2	12		C	URC_SQ_HDINN2	12		C
C19	URC_SQ_VCCRX2	12			URC_SQ_VCCRX2	12		
A23	URC_SQ_HDOUTP2	12		T	URC_SQ_HDOUTP2	12		T
C23	URC_SQ_VCCOB2	12			URC_SQ_VCCOB2	12		
B23	URC_SQ_HDOUTN2	12		C	URC_SQ_HDOUTN2	12		C
C22	URC_SQ_VCCTX2	12			URC_SQ_VCCTX2	12		
B22	URC_SQ_HDOUTN3	12		C	URC_SQ_HDOUTN3	12		C

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
A21	URC_SQ_VCCOB3	12			URC_SQ_VCCOB3	12		
A22	URC_SQ_HDOUTP3	12		T	URC_SQ_HDOUTP3	12		T
C21	URC_SQ_VCCTX3	12			URC_SQ_VCCTX3	12		
B19	URC_SQ_HDINN3	12		C	URC_SQ_HDINN3	12		C
B18	URC_SQ_VCCIB3	12			URC_SQ_VCCIB3	12		
A19	URC_SQ_HDINP3	12		T	URC_SQ_HDINP3	12		T
C18	URC_SQ_VCCRX3	12			URC_SQ_VCCRX3	12		
D23	PT73B	1		C	PT82B	1		C
GNDIO	GNDIO1	-			GNDIO1	-		
E21	PT73A	1		T	PT82A	1		T
D26	PT72B	1		C	PT81B	1		C
E26	PT72A	1		T	PT81A	1		T
E23	PT71B	1		C	PT80B	1		C
-	-	-			VCCIO1	1		
G22	PT71A	1		T	PT80A	1		T
VCCIO	VCCIO1	1			-	-		
D22	PT70B	1		C	PT79B	1		C
F21	PT70A	1		T	PT79A	1		T
G18	PT69B	1		C	PT78B	1		C
H18	PT69A	1		T	PT78A	1		T
D20	PT68B	1		C	PT77B	1		C
GNDIO	GNDIO1	-			GNDIO1	-		
D21	PT68A	1		T	PT77A	1		T
E20	PT67B	1		C	PT76B	1		C
E19	PT67A	1		T	PT76A	1		T
D19	PT66B	1		C	PT75B	1		C
VCCIO	VCCIO1	1			VCCIO1	1		
E18	PT66A	1		T	PT75A	1		T
D18	PT65B	1		C	PT74B	1		C
C17	PT65A	1		T	PT74A	1		T
A17	PT64B	1		C	PT73B	1		C
B17	PT64A	1		T	PT73A	1		T
GNDIO	GNDIO1	-			GNDIO1	-		
VCCIO	VCCIO1	1			VCCIO1	1		
J18	NC	-			PT66B	1		C
J19	NC	-			PT66A	1		T
H17	NC	-			PT65B	1		C
J17	NC	-			PT65A	1		T
F18	NC	-			PT64B	1		C
F17	NC	-			PT64A	1		T
-	-	-			GNDIO1	-		
A16	PT54B	1		C	PT63B	1		C
B16	PT54A	1		T	PT63A	1		T
G17	PT53B	1		C	PT62B	1		C
G16	PT53A	1		T	PT62A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
H16	PT52B	1		C	PT61B	1		C
F16	PT52A	1		T	PT61A	1		T

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	**Ball/Pad Function**	**Bank**	**Dual Function**	**Differential**
GNDIO	GNDIO2	-		
M27	PR47B	2	RDQ45	C (LVDS)*
M28	PR47A	2	RDQ45	T (LVDS)*
H30	PR46B	2	RDQ45	C
G30	PR46A	2	RDQ45	T
VCCIO	VCCIO2	2		
M25	PR45B	2	RDQ45	C (LVDS)*
M26	PR45A	2	RDQS45	T (LVDS)*
L30	PR44B	2	RDQ45	C
GNDIO	GNDIO2	-		
L29	PR44A	2	RDQ45	T
L28	PR43B	2	RDQ45	C (LVDS)*
L27	PR43A	2	RDQ45	T (LVDS)*
H29	PR42B	2	RDQ45	C
VCCIO	VCCIO2	2		
G29	PR42A	2	RDQ45	T
L22	PR41B	2	RDQ45	C (LVDS)*
M22	PR41A	2	RDQ45	T (LVDS)*
F30	PR40B	2		C
GNDIO	GNDIO2	-		
F29	PR40A	2		T
VCCIO	VCCIO2	2		
GNDIO	GNDIO2	-		
E30	PR34B	2	RDQ32	C (LVDS)*
E29	PR34A	2	RDQ32	T (LVDS)*
-	-	-		
L25	PR33B	2	RDQ32	C
L26	PR33A	2	RDQ32	T
VCCIO	VCCIO2	2		
H28	PR32B	2	RDQ32	C (LVDS)*
J28	PR32A	2	RDQS32	T (LVDS)*
G28	PR31B	2	RDQ32	C
GNDIO	GNDIO2	-		
G27	PR31A	2	RDQ32	T
L24	PR30B	2	RDQ32	C (LVDS)*
L23	PR30A	2	RDQ32	T (LVDS)*
D30	PR29B	2	RDQ32	C
VCCIO	VCCIO2	2		
D29	PR29A	2	RDQ32	T
K24	PR28B	2	RDQ32	C (LVDS)*
K25	PR28A	2	RDQ32	T (LVDS)*
J27	PR26B	2	RDQ23	C
GNDIO	GNDIO2	-		

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
K11	NC	-			NC	-		
K12	NC	-			NC	-		
K13	NC	-			NC	-		
K23	NC	-			NC	-		
K24	NC	-			NC	-		
K25	NC	-			NC	-		
K26	NC	-			NC	-		
L11	NC	-			NC	-		
L12	NC	-			NC	-		
L13	NC	-			NC	-		
L14	NC	-			NC	-		
L21	NC	-			NC	-		
L22	NC	-			NC	-		
L23	NC	-			NC	-		
L24	NC	-			NC	-		
L25	NC	-			NC	-		
L26	NC	-			NC	-		
M11	NC	-			NC	-		
M24	NC	-			NC	-		
M25	NC	-			NC	-		
M6	NC	-			NC	-		
M8	NC	-			NC	-		
N10	NC	-			NC	-		
N11	NC	-			NC	-		
P10	NC	-			NC	-		
P25	NC	-			NC	-		
P26	NC	-			NC	-		
R9	NC	-			NC	-		
T11	NC	-			NC	-		
U11	NC	-			NC	-		
W11	NC	-			NC	-		
Y10	NC	-			NC	-		
Y11	NC	-			NC	-		
R15	VCCPLL	-			VCCPLL	-		
R20	VCCPLL	-			VCCPLL	-		
Y15	VCCPLL	-			VCCPLL	-		
Y20	VCCPLL	-			VCCPLL	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

*** For density migration, board design must take into account that these sysCONFIG pins are dual function for the lower density devices (ECP2M20 and ECP2M35). They can be either sysCONFIG pins or general purpose I/Os. These pins are dedicated pins for the higher density devices (ECP2M50, ECP2M70, and ECP2M100).

****Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M100E-5F1152C	520	1.2V	-5	fpBGA	1152	COM	100
LFE2M100E-6F1152C	520	1.2V	-6	fpBGA	1152	COM	100
LFE2M100E-7F1152C	520	1.2V	-7	fpBGA	1152	COM	100
LFE2M100E-5F900C	416	1.2V	-5	fpBGA	900	COM	100
LFE2M100E-6F900C	416	1.2V	-6	fpBGA	900	COM	100
LFE2M100E-7F900C	416	1.2V	-7	fpBGA	900	COM	100